

Armstrong, Westerman, Hattori, McLeland & Naughton, LLP

ARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

entitled				
METHOD FO	OR PURIFICATION OF V	INYL POLYMERS	 	
the specification of	which is attached hereto unl	less the following is check	ed	
	gust 24, 2001 as United Statended on (if applicable		<u>9/938.310</u> or PCT Internation	al Application Number
	have reviewed and understa amendment referred above.	and the contents of the above	ve-identified specification, in	cluding the claim(s),
I acknowledge the Regulations, § 1.56		which is material to patent	tability as defined in Title 37	, Code of Federal
patent or inventor's		have also identified below	e, § 119 (a) – (d) of any foreign application for porty is claimed	
_	Timig date before that of the	application for which pro	Trey is claimed.	Priority Claimed
(List prior foreign applications. See note A on back of this page)	2000-254841	JAPAN	25/August/2000	⊠ Yes □ No
	(Number)	(Country)	(Day/Month/Year Filed)	
	2000-254842	JAPAN	25/August/2000	⊠ Yes □ No
	(Number)	(Country)	(Day/Month/Year Filed)	
				☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
				Yes No
	(Number)	(Country)	(Day/Month/Year Filed)	
(See note B on back	k of this page)	See attached list for addi	tional prior foreign application	ons
insofar as the subjet the manner provid information which	ect matter of each of the clai ed by the first paragraph of is material to patentability	ms of this application is n of Title 35, United States as defined in Title 37, C	f any United States application of disclosed in the prior Unitable Code, ' 112, I acknowled Code of Federal Regulations or PCT international filing data.	ted States application in ge the duty to disclose 1.56 which became
(List prior II S	•		Sta	tus
(List prior U.S. Applications)				☐ Pending ☐ doned
	Application Serial No.)	(Filing Date)	_	



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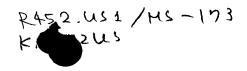
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(Application Serial No.)	(Filing Date)	Patented Pending Abandoned
(Application Serial No.)	(Filing Date)	Patented Pending Abandoned





I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

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PATENT TRADEMARK OFFICE

Please direct all communications to the following address:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, '1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

(See note C)	Full name of sole or first inventor (given name, family name)		Nao FUJITA ·			
	Inventor's signature	nao Frigita	Date OC'	T. 25. 2001		
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	Full name of second inventor (given name, family name)		Kenichi KITANO			
	Inventor's signature	Kenichi Kitana	Date OC	T. 2 5. 2001		
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	,					
		entor (given name, family name)		i NAKAGAWA		
	Inventor's signature	yelli Rolgagan	Date OC'	<u>r. 25, 2001</u>		
	Residence	Osaka, Japan	Citizenship	Japanese		
	Post Office Address	c/o Functional Materials Research Labora	atories, Osaka Factory, Kaneka Corporation			
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		Full name of fourth inventor (given name, family name)				
	Inventor's signature		Date			
	Residence		Citizenship			
	Post Office Address					
	Full name of fifth inventor (given name, family name)					
	Inventor's signature		Date			
	Residence		Citizenship			
•	Post Office Address					

NOTES



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Full name of sixth inventor (given name, family name)	
Inventor's signature	Date
Residence	Citizenship
Post Office Address	
Full name of seventh inventor (given name, family nam	ne)
Inventor's signature	Date
Residence	Citizenship
Post Office Address	
Full name of eighth inventor (given name, family name	e)
Inventor's signature	Date
Residence	Citizenship
Post Office Address .	